Multilayer Ceramic Chip Capacitors

1 of 3 Creation Date : April 11, 2017 (GMT)

C1005X5R1C223M050BA

Recommended Land Pattern (PB)

Recommended Land Pattern (PC)



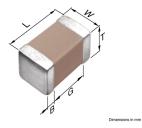






TDK item description C1005X5R1C223MT****

Applications	Commercial Grade	
Feature	General General (Up to 50V)	
Series	C1005 [EIA 0402]	
Status	Production (Not Recommended for New Design)	



Size	
Length(L)	1.00mm ±0.05mm
Width(W)	0.50mm ±0.05mm
Thickness(T)	0.50mm ±0.05mm
Terminal Width(B)	0.10mm Min.
Terminal Spacing(G)	0.30mm Min.
Recommended Land Pattern (PA)	0.30mm to 0.50mm

0.35mm to 0.45mm

0.40mm to 0.60mm

Electrical Characteristics		
Capacitance	22nF ±20%	
Rated Voltage	16VDC	
Temperature Characteristic	X5R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	4545ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	10000pcs

[!] Images are for reference only and show exemplary products.

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[!] All specifications are subject to change without notice.

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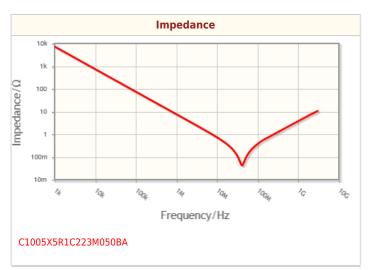




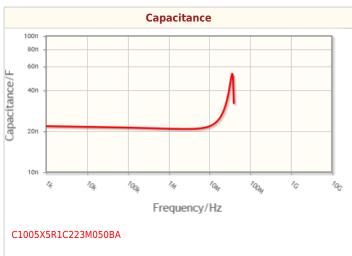


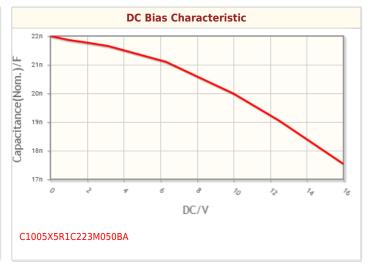


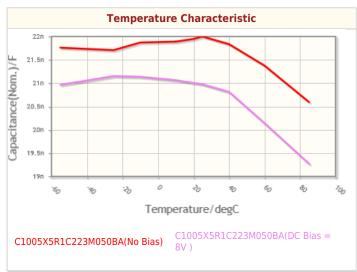
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

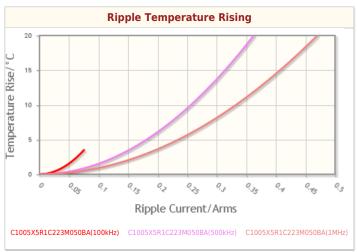












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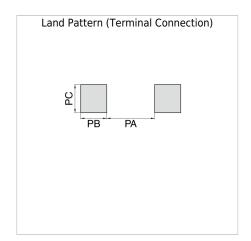






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Associated Images



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